

3.2x1.6mm SMD CHIP LED LAMP





• Ideal for indication light on hand held products

www.SunLED.com

• Long life and robust package

• Variety of lens types and color choices available

 \bullet Package: 2000 pcs / reel

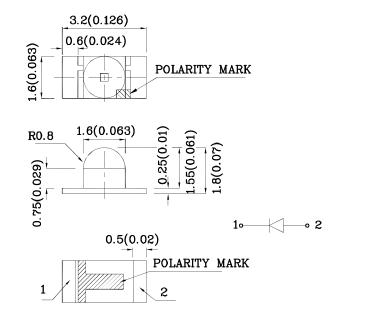
• Moisture sensitivity level : level 3

• RoHS compliant





Package Schematics



Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is $\pm 0.2(0.008")$ unless otherwise noted.
- 3. Specifications are subject to change without notice.

Absolute Maximum Ratings (T _A =25°C)		M2ACR (AlGaInP)	Unit	
Reverse Voltage	V_{R}	5	V	
Forward Current	I_{F}	30	mA	
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	i_{FS}	150	mA	
Power Dissipation	P_{D}	84	mW	
Operating Temperature	$T_{\rm A}$	-40 ~ +85	°C	
Storage Temperature	Tstg	-40 ~ +85		

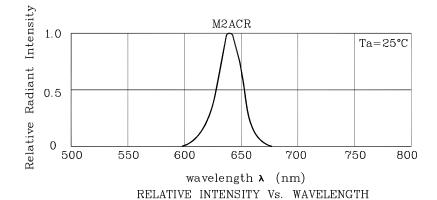
Operating Characteristics (T _A =25°C)		M2ACR (AlGaInP)	Unit	
Forward Voltage (Typ.) (I _F =20mA)	V_{F}	2.2	V	
Forward Voltage (Max.) (I _F =20mA)	V_{F}	2.8	V	
Reverse Current (Max.) $(V_R=5V)$	${ m I}_{ m R}$	10	uA	
Wavelength of Peak Emission (Typ.) (I _F =20mA)	λΡ	640	nm	
Wavelength of Dominant Emission (Typ.) $(I_F=20\text{mA})$	λD	625	nm	
Spectral Line Full Width At Half-Maximum (Typ.) (I _F =20mA)	$\triangle \lambda$	25	nm	
Capacitance (Typ.) (V _F =0V, f=1MHz)	С	27	pF	

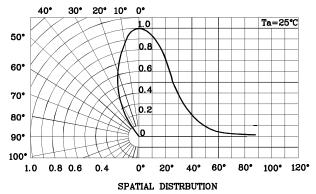
Part Number	Emitting Color	Emitting Material	Lens-color	$rac{ ext{Luminous}}{ ext{Intensity}} \ (ext{I}_{ ext{F}}{=}20 ext{mA}) \ ext{mcd}$		Wavelength nm λP	Viewing Angle 20 1/2
				min.	typ.		
ZM2ACR55W-3	Red	AlGaInP	Water Clear	5000	7990	640	50°

Apr 18,2011 SDSA7123 V3 Layout: Maggie L.

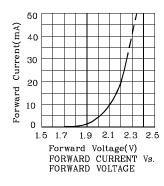


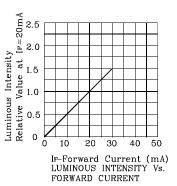


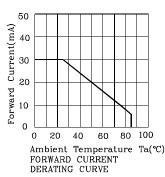


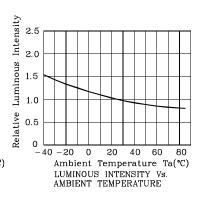


❖ M2ACR



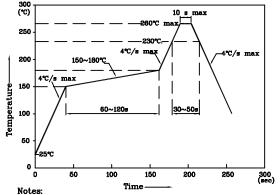






LED is recommended for reflow soldering and soldering profile is shown below.

Reflow Soldering Profile for SMD Products (Pb-Free Components)

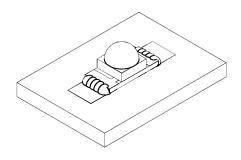


- 1. Maximum soldering temperature should not exceed 260°C
- 2. Recommended reflow temperature: 145°C-260°C
- 3. Do not put stress to the epoxy resin during high temperatures conditions

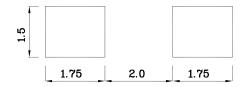




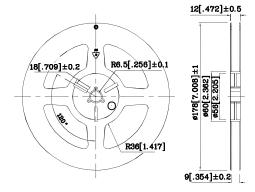
❖ The device has a single mounting surface. The device must be mounted according to the specifications.



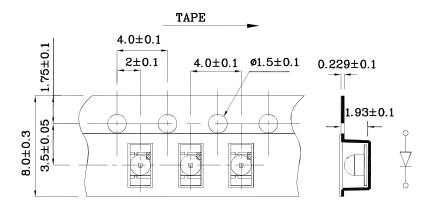
❖ Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



❖ Reel Dimension



❖ Tape Specification (Units:mm)



Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

- 1. Wavelength: +/-1nm
- 2. Luminous intensity / luminous flux: +/-15%
- 3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.





PACKING & LABEL SPECIFICATIONS

